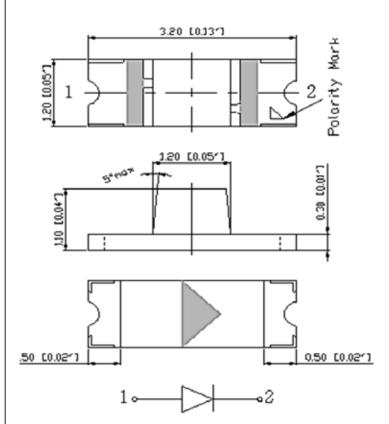
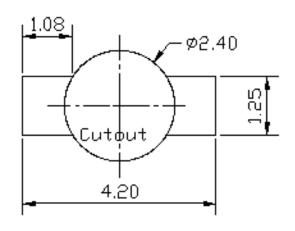


# SPECIFICATION CS124AG2C-R

### **PACKAGE OUTLINES**



### **RECOMMENDED SOLDER PAD**



ITEM	MATERIALS			
Resin (Mold)	Ероху			
Lens Color	Water Transparent			
Dice	AlGalnP			
Emitted Color	Yellow Green			

#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm$  0.25mm (0.01") unless otherwised noted.
- 3. Specifications are subject to change without notice.

Part Number Chip Material		Color of Emission	Lens Type	Viewing Angle
CS124AG2C-R	InGaAIP	Green	Water Clear	140°





### **ABSOLUTE MAXIMUM RATINGS**

(TA=25°C)

Parameter	Symbol	Max Rating	Unit	
Forward Current	lF	30	mA	
Reverse Current @ 5V	lR	10	μA	
Power Dissipation	Pd	75	mW	
Operating Temperature Range	Тор	-40~+85	°C	
Storage Temperature Range	Тѕтс	-40~+85	°C	
Peak Pulsing Current (1/10 duty f = 10KHz)	lFP	125	mA	
Soldering Temperature	TsoL	Max 260°C for	5 sec Max	

# **OPTICAL-ELECTRICAL CHARACTERISTICS**

(TA=25°C)

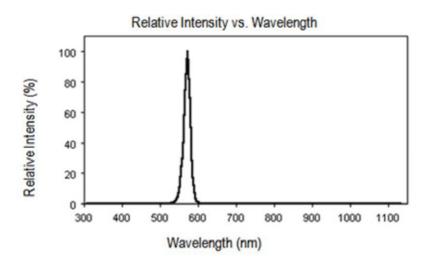
Parameter	Symbol	Test Condition	Value			Lloit
			Min	Тур	Max	Unit
Luminous Intensity	lv	IF = 20mA	32	60	1	mcd
Forward Voltage	VF	IF = 20mA	1	2.0	2.5	V
Reverse Leakage Current	lR	VR = 5V	-	-	10	μΑ
Viewing Angle at 50% Iv	201/2	IF = 20mA	ı	140	ı	Deg
Peak Wavelength	λР	IF = 20mA	-	572	-	nm
Dominant Wavelength	λD	IF = 20mA	565	570	576	nm

<sup>\*</sup>Tolerance of viewing angle: -10 / +5 deg.

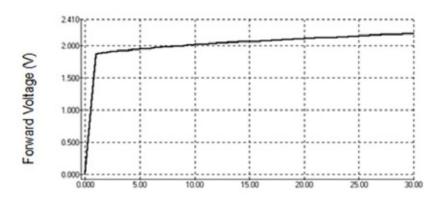




# **OPTICAL CHARACTERISTIC CURVES**

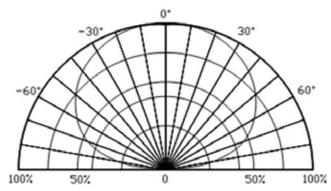


### Forward Current vs. Forward Voltage



### Forward Current (mA)

#### **Directive Characteristics**



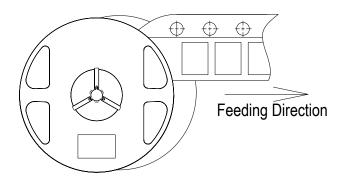
RoHS Compliant



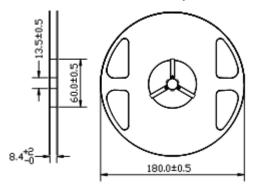
### **PACKAGING SPECIFICATION**

### PACKAGING SPECIFICATIONS

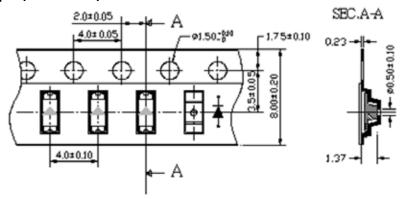
### **Feeding Direction**



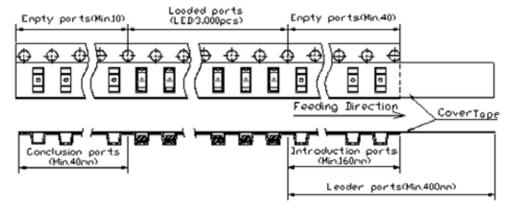
### Dimensions of Reel (Unit: mm)



### **Dimensions of Tape (Unit: mm)**



### **Arrangement of Tape**



#### Notes:

- 1. Empty component pockets are sealed with top cover tape
- 2. Maximum number of missing lamp is two
- 3. Cathode is oriented towards the tape sprocket hole
- 4. 3,000 pcs/Reel

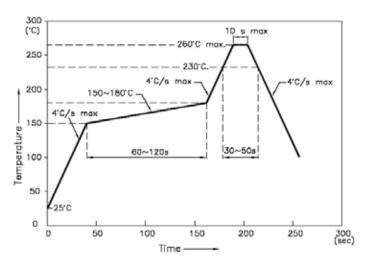




### **SOLDERING CONDITIONS**

### **SOLDERING PROFILE**

Reflow Temp/Time



- We recommend the reflow temperature 245°C (±5 °C) & the maximum soldering temperature should be limited to 260 °C.
- Do not cause stress to the epoxy resin while it is exposed to high temperature.
- Number of reflow process should be 2 times or less.
- Soldering Iron:
  - Basic spec is ≤ 5 sec when 260 °C. If the temperature is higher, time should be shorter (+10 °C → -1 sec). Power dissipation of iron should be smaller than 20W and temperature should be controllable. Surface temperature of the device should be under 230 °C.
- Rework:
  - Customer must finish rework within 5 sec under 260 °C
  - The head of iron cannot touch copper foil
  - Twin-head type is preferred

